onsemi

MOSFET – Power, Single N-Channel

60 V, 50 A, 9.3 m Ω

NTTFS5CS73NL

Features

- Small Footprint (3.3x3.3 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Symbol	Parameter			Value	Unit
V _{DSS}	Drain-to-Source Voltage			60	V
V _{GS}	Gate-to-Source Voltage	Gate-to-Source Voltage			V
Ι _D	Continuous Drain		$T_{C} = 25^{\circ}C$	50	А
	Current R _{θJC} (Notes 1, 3)	Steady	$T_{C} = 100^{\circ}C$	35	
PD	Power Dissipation	State	T _C = 25°C	46	W
	R _{θJC} (Note 1)		$T_{C} = 100^{\circ}C$	23	
Ι _D	Continuous Drain		$T_A = 25^{\circ}C$	13	А
	Current R _{θJA} (Notes 1, 2, 3)	Steady	T _A = 100°C	9	
PD	Power Dissipation	State	T _A = 25°C	3.1	W
	R _{θJA} (Notes 1 & 2)	$T_A = 100^{\circ}C$		1.6	
I _{DM}	Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	290	А
T _J , T _{stg}	Operating Junction and Storage Temperature			–55 to +175	°C
۱ _S	Source Current (Body Diode)			52	А
E _{AS}	Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 2.3 A)			88	mJ
ΤL	Lead Temperature for S (1/8" from case for 10 s		urposes	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Junction-to-Case - Steady State	3.2	°C/W
$R_{\theta JA}$	Junction-to-Ambient - Steady State (Note 2)	48	

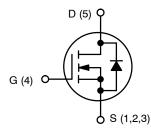
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	9.3 mΩ @ 10 V	50.4
60 V	13.3 m Ω @ 4.5 V	50 A

N-CHANNEL MOSFET



MARKING DIAGRAM

S73L	= Specific Device Code
Α	= Assembly Location
Y	= Year
WW	= Work Week
•	= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet. NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 5.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Test Condition		Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS	•					
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	V _{GS} = 0 V, I _D =	= 250 μA	60			V
V _{(BR)DSS} / T _J	Drain-to-Source Breakdown Voltage Temperature Coefficient				28		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0 V, V _{DS} = 60 V	$T_J = 25^{\circ}C$			10	
		$V_{DS} = 60 V$	T _J = 125°C			250	μΑ
I _{GSS}	Gate-to-Source Leakage Current	$V_{DS} = 0 V, V_{GS} = 20 V$				100	nA
ON CHARA	CTERISTICS (Note 4)						
V _{GS(TH)}	Gate Threshold Voltage	$V_{GS}=V_{DS},\ I_{D}=35\ \mu A$		1.2		2.0	V
$V_{GS(TH)}/T_J$	Threshold Temperature Coefficient				-4.5		mV/°C
RDS(on)	Drain-to-Source On Resistance	V _{GS} = 10 V	In = 25 A		8.0	9.3	

9.3

13.3

mΩ

S

$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	DS(on)	Diam-10-30010e On Resistance	$v_{GS} = 10 v$	$I_D = 25 A$	0.0
g_{FS} Forward Transconductance $V_{DS} = 15 \text{ V}, I_D = 25 \text{ A}$ 37			V _{GS} = 4.5 V	I _D = 25 A	11
	9 _{FS}	Forward Transconductance	V _{DS} =15 V, I _D = 25 A		37

CHARGES AND CAPACITANCES

C _{ISS}	Input Capacitance		880	
C _{OSS}	Output Capacitance	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V	450	pF
C _{RSS}	Reverse Transfer Capacitance		11	
Q _{G(TOT)}	Total Gate Charge	V_{GS} = 4.5 V, V_{DS} = 30 V; I_{D} = 25 A	4.5	nC
Q _{G(TOT)}	Total Gate Charge	V_{GS} = 10 V, V_{DS} = 30 V; I_{D} = 25 A	9.5	nC
Q _{G(TH)}	Threshold Gate Charge		1.0	
Q _{GS}	Gate-to-Source Charge		2.0	nC
Q _{GD}	Gate-to-Drain Charge	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 25 A	0.8	
V _{GP}	Plateau Voltage		2.9	V

SWITCHING CHARACTERISTICS (Note 5)

t _{d(ON)}	Turn-On Delay Time		9.0	
t _r	Rise Time	V _{GS} = 4.5 V, V _{DS} = 30 V,	50	
t _{d(OFF)}	Turn-Off Delay Time	$I_{\rm D}$ = 25 A, $R_{\rm G}$ = 2.5 Ω	13	ns
t _f	Fall Time		3.0	

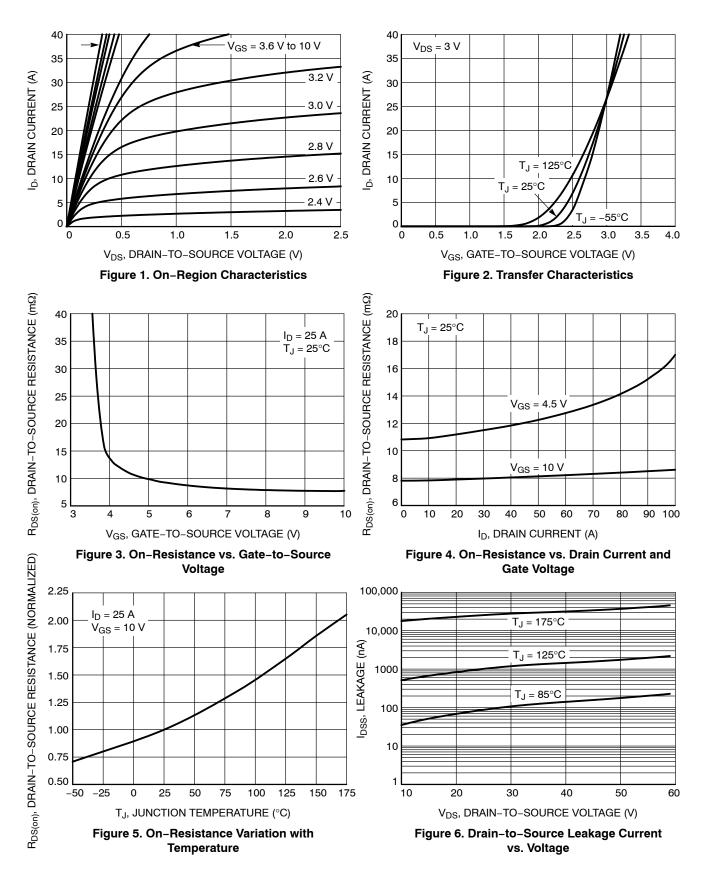
DRAIN-SOURCE DIODE CHARACTERISTICS

V _{SD}	Forward Diode Voltage	V _{GS} = 0 V, I _S = 25 A	$T_J = 25^{\circ}C$	0.9	1.2	V
		I _S = 25 A	T _J = 125°C	0.8		v
t _{RR}	Reverse Recovery Time			28		
ta	Charge Time	V_{GS} = 0 V, dls/dt = 100 A/µs, I_S = 25 A		14		ns
t _b	Discharge Time			14		
Q _{RR}	Reverse Recovery Charge			18		nC

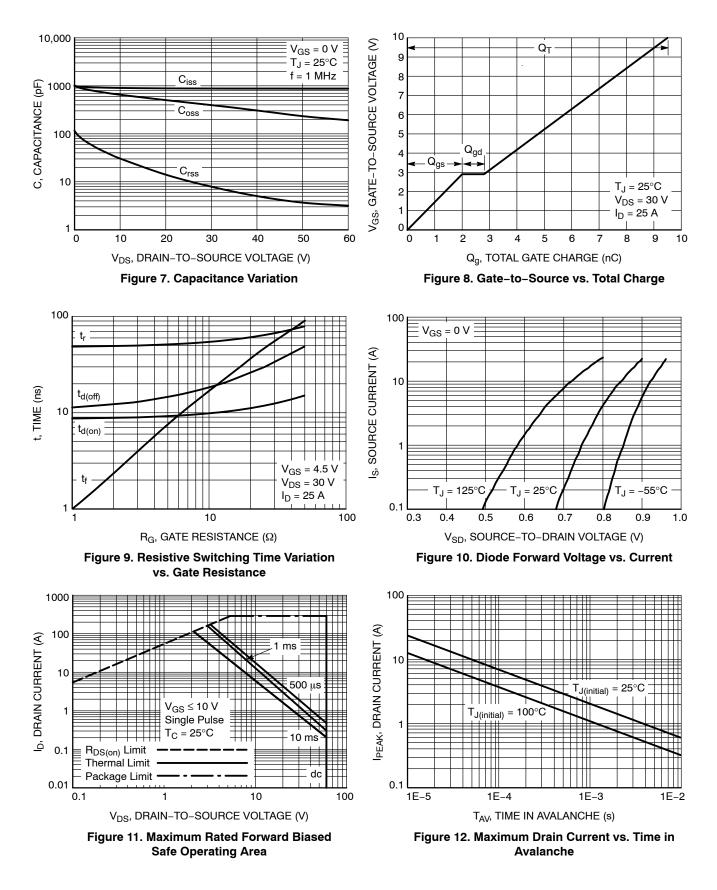
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.

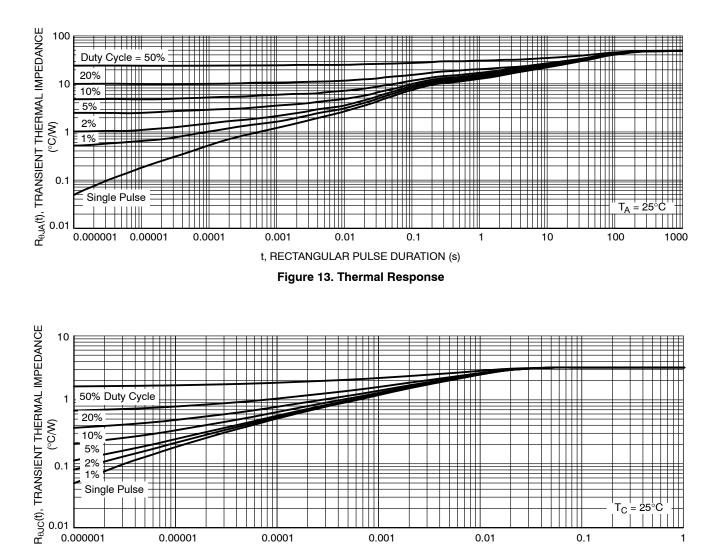
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)



t, RECTANGULAR PULSE DURATION (s) Figure 14. Thermal Response

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTTFS5CS73NLTAG	S73L	DFN5 (Pb–Free)	1500 / Tape & Reel

DISCONTINUED (Note 6)

NTTFS5CS73NLTWG	S73L	DFN5	5000 / Tape & Reel
		(Pb-Free)	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

6. DISCONTINUED: This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on <u>www.onsemi.com</u>.





 DOCUMENT NUMBER:
 98AON30561E
 Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.

 DESCRIPTION:
 WDFN8 3.3X3.3, 0.65P
 PAGE 1 OF 1

 onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation

special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

© Semiconductor Components Industries, LLC, 2019

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>